

Analog Devices Welcomes Hittite Microwave Corporation

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Typical Applications

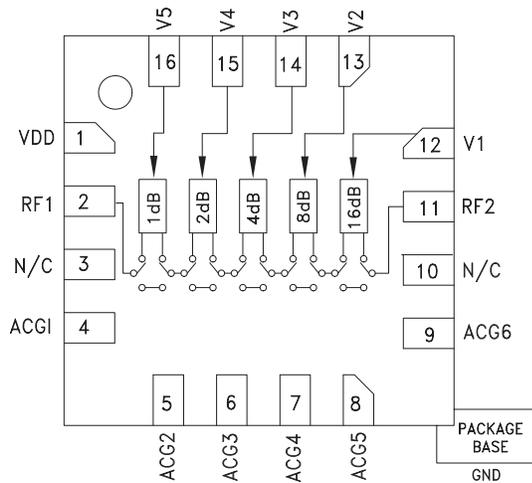
The HMC470LP3(E) is ideal for:

- Cellular; UMTS/3G Infrastructure
- ISM, MMDS, WLAN, WiMAX
- Microwave Radio & VSAT
- Test Equipment and Sensors

Features

- 1 dB LSB Steps to 31 dB
- Single Control Line Per Bit
- TTL/CMOS Compatible Control
- ± 0.3 dB Typical Step Error
- Single +5V Supply
- 16 Lead 3x3mm SMT Package: 9mm²
- Included in the HMC-DK004 Designer's Kit

Functional Diagram



TOP VIEW

General Description

The HMC470LP3(E) is a broadband 5-bit GaAs IC digital attenuators in low cost leadless surface mount packages. This single positive control line per bit digital attenuator incorporates off chip AC ground capacitors for near DC operation, making it suitable for a wide variety of RF and IF applications. Covering DC to 3 GHz, the insertion loss is less than 1.5 dB typical. The attenuator bit values are 1 (LSB), 2, 4, 8, and 16 dB for a total attenuation of 31 dB. Attenuation accuracy is excellent at ± 0.3 dB typical step error with an IIP3 of +45 dBm. Five TTL/CMOS control inputs are used to select each attenuation state. A single Vdd bias of +5V is required.

Electrical Specifications,

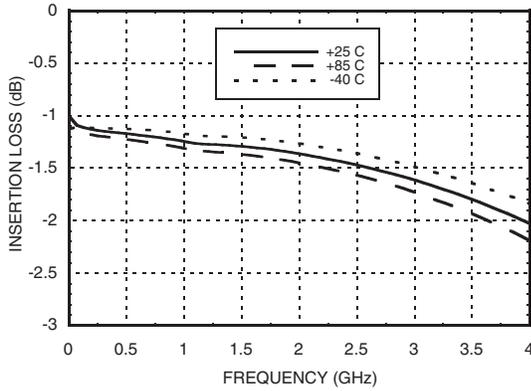
$T_a = +25^\circ C$, With $V_{dd} = +5V$ & $V_{ctl} = 0/+5V$ (Unless Otherwise Noted)

Parameter	Frequency (GHz)	Min.	Typ.	Max.	Units
Insertion Loss	DC - 1.5 GHz		1.3	1.6	dB
	1.5 - 2.3 GHz		1.4	1.7	dB
	2.3 - 3.0 GHz		1.7	2.0	dB
Attenuation Range	DC - 3 GHz		31		dB
Return Loss (RF1 & RF2, All Atten. States)	DC - 3 GHz		17		dB
Attenuation Accuracy: (Referenced to Insertion Loss) All Attenuation States	DC - 2.3 GHz	± (0.3 + 2% of Atten. Setting) Max.			dB
	2.3 - 3.0 GHz	± (0.3 + 3% of Atten. Setting) Max.			dB
	2.3 - 3.0 GHz	± (0.3 + 6% of Atten. Setting) Max.			dB
Input Power for 0.1 dB Compression	0.1 - 3.0 GHz		20		dBm
Input Third Order Intercept Point (Two-Tone Input Power= 0 dBm Each Tone)	0.1 - 3.0 GHz	REF - 15 dB States	45		dBm
		16 - 31 dB States	35		dBm
Switching Characteristics	DC - 3 GHz	tRISE, tFALL (10/90% RF)	160		ns
		tON, tOFF (50% CTL to 10/90% RF)	180		ns

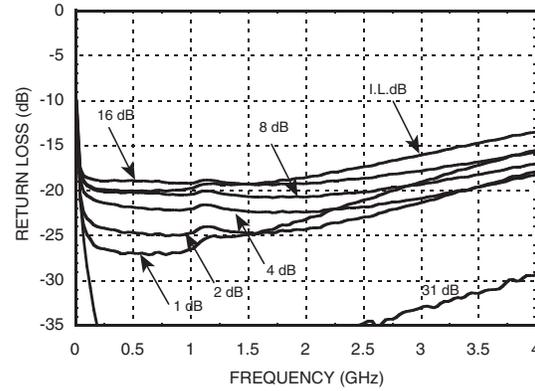
For price, delivery, and to place orders, please contact Hittite Microwave Corporation:
 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373
 Order On-line at www.hittite.com

1 dB LSB GaAs MMIC 5-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 3 GHz

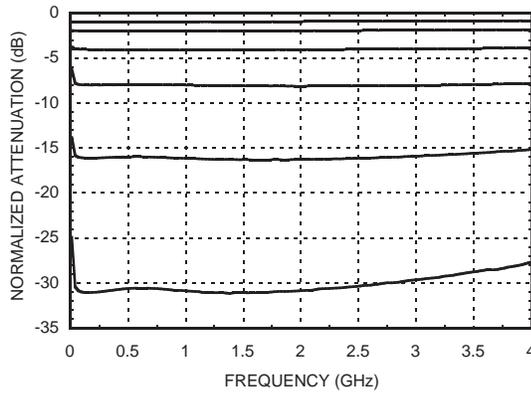
Insertion Loss



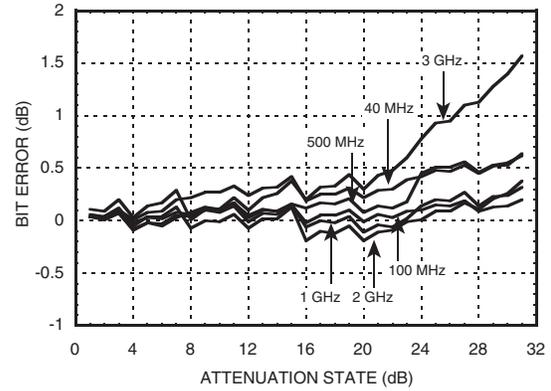
Return Loss RF1, RF2 (Only Major States are Shown)



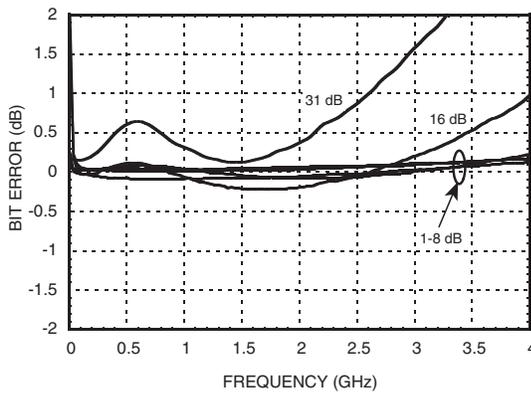
Normalized Attenuation (Only Major States are Shown)



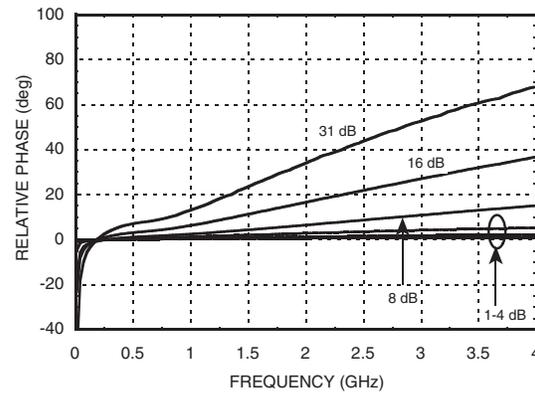
Bit Error vs. Attenuation State



Bit Error vs. Frequency (Only Major States are Shown)



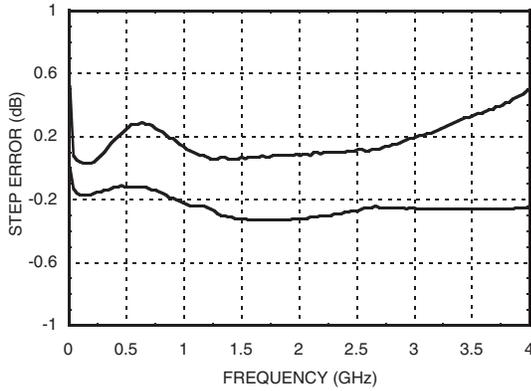
Relative Phase vs. Frequency (Only Major States are Shown)





1 dB LSB GaAs MMIC 5-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 3 GHz

Worst Case Step Error Between Successive Attenuation States



Bias Voltage & Current

Vdd = +5V ± 10%	
Vdd (V)	Idd (Typ.) (mA)
+4.5	4.0
+5.0	4.2
+5.5	4.4

Control Voltage

State	Bias Condition
Low	0 to +0.8V @ -5 uA Typ.
High	+2.0 to + 5 Vdc @ 40 uA Typ.

Note: Vdd = +5V

Truth Table

Control Voltage Input					Attenuation State RF1 - RF2
V1 16 dB	V2 8 dB	V3 4 dB	V4 2 dB	V5 1 dB	
High	High	High	High	High	Reference I.L.
High	High	High	High	Low	1 dB
High	High	High	Low	High	2 dB
High	High	Low	High	High	4 dB
High	Low	High	High	High	8 dB
Low	High	High	High	High	16 dB
Low	Low	Low	Low	Low	31 dB

Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.

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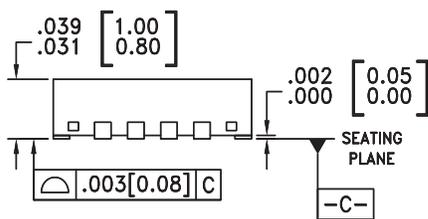
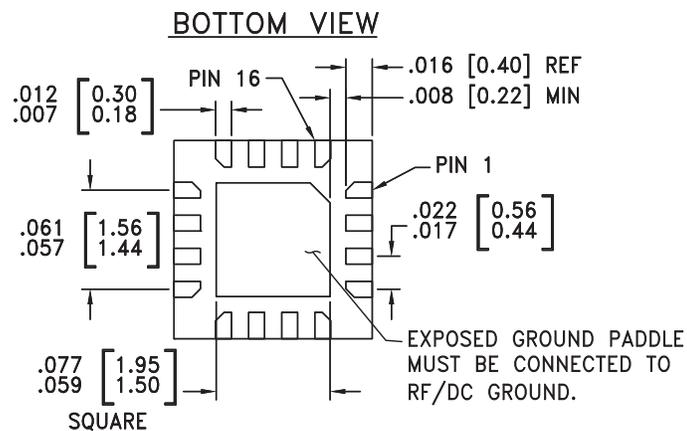
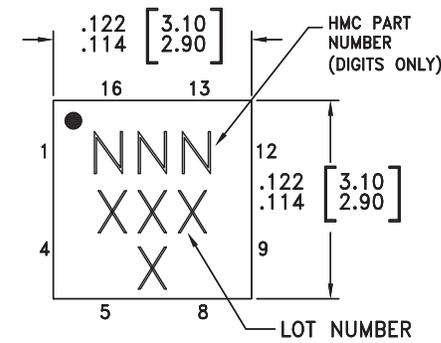
Absolute Maximum Ratings

RF Input Power (DC - 3 GHz)	+27 dBm (T = +85 °C)
Control Voltage Range (V1 to V5)	-1V to Vdd +1V
Bias Voltage (Vdd)	+7V
Channel Temperature	150 °C
Continuous Pdiss (T = 85 °C) (derate 7.7 mW/°C above 85 °C)	0.5 W
Thermal Resistance	130 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

- LEADFRAME MATERIAL: COPPER ALLOY
- DIMENSIONS ARE IN INCHES [MILLIMETERS]
- LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC470LP3	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	470 XXXX
HMC470LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	470 XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

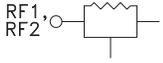
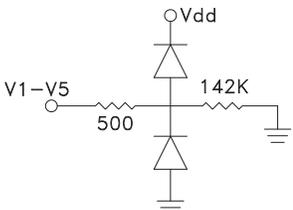


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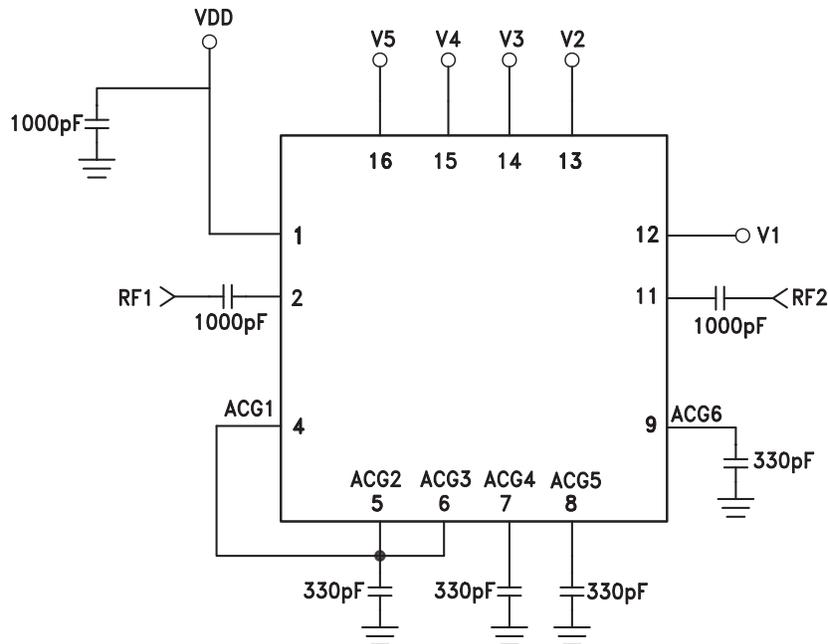
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ATTENUATORS - SMT

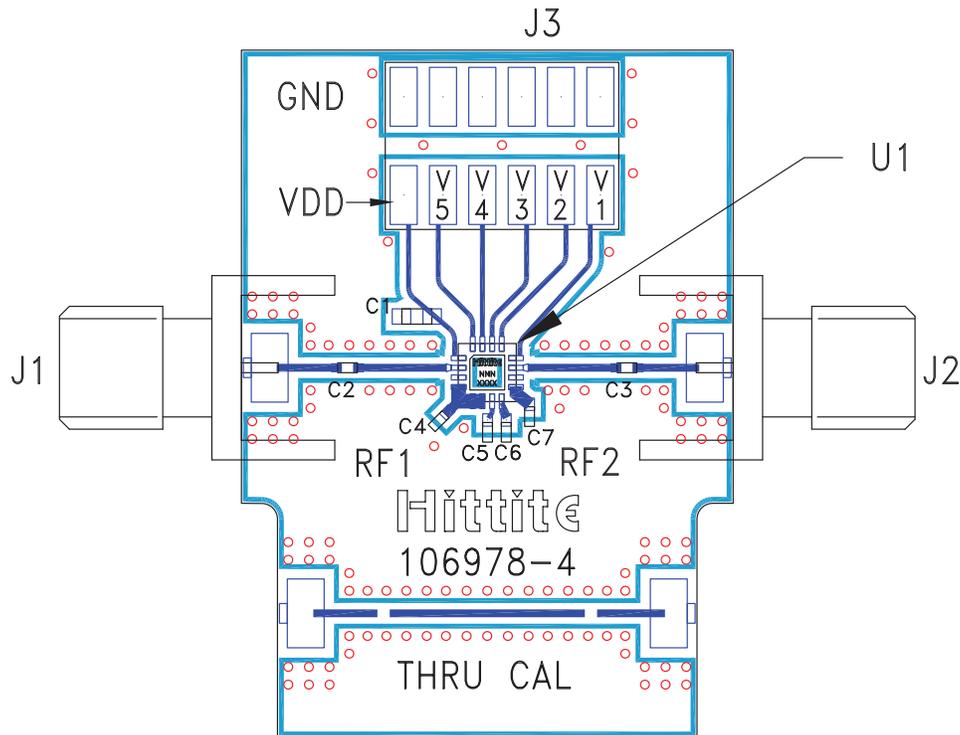
Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	Vdd	Supply Voltage.	
2, 11	RF1, RF2	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required. Select value based on lowest frequency of operation.	
3, 10	N/C	These pins should be connected to PCB RF ground to maximize performance.	
4 - 9	ACG1 - ACG6	External capacitor to ground is required. Select value for lowest frequency of operation. Place capacitor as close to pins as possible.	
12 - 16	V1 - V5	See truth table and control voltage table.	
	GND	Package bottom has an exposed metal paddle that must also be connected to RF Ground.	

Application Circuit



Evaluation PCB



List of Materials for Evaluation PCB 107006 [1]

Item	Description
J1 - J2	PC Mount SMA Connector
J3	12 Pin DC Connector
C1	1000 pF Capacitor, 0603 Pkg.
C2, C3	1000 pF Capacitor, 0402 Pkg.
C4 - C7	330 pF Capacitor, 0402 Pkg.
U1	HMC470LP3 / HMC470LP3E Digital Attenuator
PCB [2]	106978 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350Re

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

Mouser Electronics

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[HMC470LP3E](#) [107006-HMC470LP3](#) [HMC470LP3](#) [HMC470LP3ETR](#) [HMC470LP3TR](#)